

**ATCC**

DEC 27 2004

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The American Type Culture Collection (ATCC) has received your deposit of seeds in connection with the filing of an application for patent. The following information is provided to fulfill Patent Office requirements.

**Name and Address of Depositor:**

Pioneer Hi-Bred International, Inc.  
Attn: Steve Callstein  
7100 NW 62<sup>nd</sup> Avenue  
P.O. Box 1000  
Johnston, Iowa 50131-1000

**DOCKETED****Deposited on Behalf of:**

Pioneer Hi-Bred International, Inc.

**Date of Receipt of Seeds by the ATCC:**

November 30, 2004

**Scientific Description****Depositor's Reference****Patent Deposit Designation**

Inbred Corn (maize) seed

PHCSH

PTA-6351 - 12.5L

**The ATCC understands that:**

1. The deposit of these seeds does not grant ATCC a license, either express or implied, to infringe the patent, and our release of these seeds to others does not grant them a license, either express or implied, to infringe the patent.
2. If these seeds should die or be destroyed during the effective term of the patent, it is the responsibility of the depositor to replace them with living seeds of the same type. It is the responsibility of the depositor to provide a sufficient quantity for distribution for the deposit term.

Prior to the issuance of a U.S. Patent, the ATCC agrees in consideration for distribute these seeds or any information relating thereto or to their deposit except to the relevant patent office. After a relevant patent issues, and we are instructed to release the seeds to the public without any restrictions.

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The ATCC agrees to maintain the seeds for a period of 30 years from deposit date, or 5 years after the most recent request for a sample, whichever is longer.

We will inform you of requests for the seeds for 30 years from date of deposit.

The seeds were tested December 10, 2004 and were viable.

American Type Culture Collection

By Maria Harris  
Maria Harris, Patent Specialist  
ATCC Patent Depository

Date: December 21, 2004